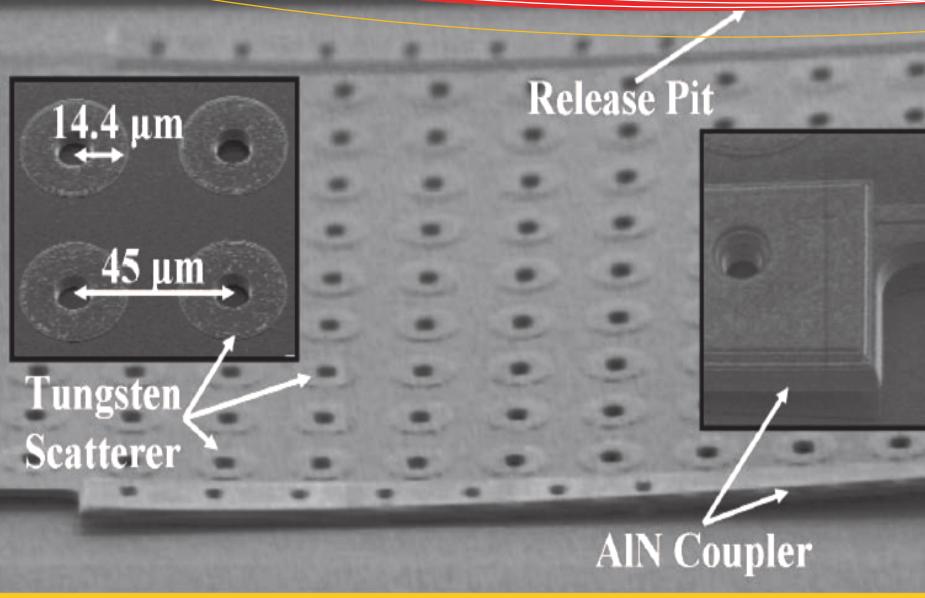




RF Acoustic Bandgap Materials



SEM image of a 67 MHz acoustic bandgap device.

POTENTIAL MARKETS AND APPLICATIONS

- RF acoustic filter isolation
- Radio-on-a-chip
- Multi-band wireless devices
- Micro-scale thermal management devices

TECHNOLOGY READINESS LEVEL

Sandia estimates this technology is at TRL 3/9: concepts demonstrated analytically and experimentally.

BENEFITS

- Provides isolation for RF resonators/filters
- Vacuum compatible
- Acoustically isolated from substrate
- CMOS-compatible

INTELLECTUAL PROPERTY

US PATENT # 7,836,566
US PATENT # 7,733,198

Acoustic micro-resonator radio frequency (RF) filters are used in nearly all wireless devices including 4G mobile networks, and cell phone radios.

Sandia-developed acoustic band gap (ABG) materials use arrays of micro-scale scatterers to block acoustic waves, offering improved isolation of RF acoustic filters for higher packaging density (smaller footprint) with reduced crosstalk.

Sandia researchers used advanced modeling and microfabrication to dramatically scale down the size of ABG devices, while enabling wafer-scale manufacture. This new class of commercially-relevant ABG materials has submicron features and frequencies in excess of 1 GHz, in bands of interest for wireless communication.

ABG materials also open the door to advancements in thermal management by controlling the acoustic vibrations that transmit heat.

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